

# 12500 TI Boulevard, MS 8640, Dallas, Texas 75243

# PCN#20230412001.1 Qualification of a new Die Attach Material for select devices

# **Change Notification / Sample Request**

**Date:** April 12, 2023 **To:** Newark/Farnell PCN

#### Dear Customer:

This is an announcement of a change to a device that is currently offered by Texas Instruments. The details of this change are on the following pages.

Texas Instruments requires acknowledgement of receipt of this notification within **30** days of the date of this notice. Lack of acknowledgement of this notice within 30 days constitutes acceptance of the change. If additional data is required, requests must be received within **30** days of this notification.

The changes discussed within this PCN will not take effect any earlier than the proposed first ship date on Page 3 of this notification, unless customer agreement has been reached on an earlier implementation of the change.

This notice does not change the end-of-life status of any product. Should product affected be on a previously issued product withdrawal/discontinuance notice, this notification does not extend the life of that product or change the life time buy offering/discontinuance plan.

For questions regarding this notice or to provide acknowledgement of this PCN, you may contact your local Field Sales Representative or the PCN Team (PCN www admin team@list.ti.com). For sample requests or sample related questions, contact your local Field Sales Representative.

Sincerely,

PCN Team SC Business Services

# 20230412001.1 Attachment: 1

### **Products Affected:**

The devices listed on this page are a subset of the complete list of affected devices. According to our records, these are the devices that you have purchased within the past twenty-four (24) months. The corresponding customer part number is also listed, if available.

**DEVICE** DRV8818PWP

**CUSTOMER PART NUMBER** 

null

Technical details of this Product Change follow on the next page(s).

PCN Number:		20230412001.1					PCN Date:		April 12, 2023	
Title: Qualification of a new die attach material for select de					erial for select device	es				
Cus	tomer Conta	ct: PCN A	lanager	Dept: Quality Services						
Proposed 1 <sup>st</sup> Shi				2023 Sample			equests d until:  May 12, 20		12, 2023	
*Sa	mple reques	ts receive	d after	May 12, 2	023 will not be s	ирр	orted.			
Change Type:										
	Assembly Site		Design			Wafer Bump Site				
	Assembly Process			□ Data Sheet			Wafer Bump Material			
$\boxtimes$	Assembly Mat			Part number change			Wafer Bump Process			
	Mechanical S			☐ Test Site			Wafer Fab Site			
☐ Packing/Shipping/Labeling [			Test Process		Щ	Wafer Fab Materials				
							Wafer Fab Process			
				PCN	Details					
Des	cription of C	hange:								
This PCN is to inform of an alternate die attach material for the devices listed below.										
	V	/hat			Current			Nev	N	
	Die atta	ch materia	I		4208458		4:	21147	<b>'</b> 0	
Rea	son for Chan	ige:								
Con	tinuity of supp	oly								
Ant	icipated impa	act on For	m, Fit, F	unction,	Quality or Reliab	lity	(positi	ve /	negative):	
Non	ie									
Impact on Environmental Ratings										
Checked boxes indicate the status of environmental ratings following implementation of this change. If below boxes are checked, there are no changes to the associated environmental ratings.										
RoHS			REAC		Green Sta	tus		IEC	62474	1
ĮΤ	☑ No Change	Σ	⊠ No Cha						nange	
		<u>'</u>		· J·						
Cha	inges to prod	uct identi	fication	resulting	from this PCN:					
Non	е									
Pro	duct Affected	d:								
DRV10987SLIPWPF		LM5176PWPR		TAS5806MDCPR		TPA3113D2PWPR				
DRV8818PWP		LM5176PWPT			TAS5806MDDCP		TPA3118D2DAP			
DRV8818PWPR		SN005805PWPR			TAS5806MDDCPR		TPA3118D2DAPR			
DRV8840PWP			SN8C0183PWP		TAS5807MDCP		TPA3130D2DAP			
DRV8840PWPR			SN8C0183PWPR		TAS5807MDCPR		TPA3130D2DAPR			
DRV8876NPWPR			SNB9039DCP-P		TLS2605RDCARG4		TPA3138D2PWP			
			TAS5805M0PWPR				TPA3138D2PWPR			
			TAS5805M0PWPR TAS5805MPWP		TPA3110D2PWP					
DR	V8876PWPR	TAS	8U5MPW	۲	TPA3110D2PWPR T		TPS8802DCPR			

DRV8876PWPT	TAS5805MPWPR	TPA3113D2PWP
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TI Information Selective Disclosure

### **Qualification Report**

#### Approve Date 07-APRIL -2023

#### **Qualification Results**

#### Data Displayed as: Number of lots / Total sample size / Total failed

Туре	#	Test Name	Condition	Duration	Qual Device: TAS5807MDCPR	Qual Device: TLS2605RDCARG4	QBS Reference: LP8880DCPRQ1
HAST	A2	Biased HAST	130C/85%RH	96 Hours	-	-	3/231/0
UHAST	A3	Autoclave	121C/15psig	96 Hours	3/231/0	3/231/0	3/231/0
TC	A4	Temperature Cycle	-65C/150C	500 Cycles	3/231/0	3/231/0	3/231/0
HTSL	A6	High Temperature Storage Life	175C	500 Hours	-	-	3/135/0
SD	С3	PB-Free Solderability	Precondition w.155C Dry Bake (4 hrs +/- 15 minutes)	-	-	-	1/15/0
PD	C4	Physical Dimensions	Cpk>1.67	-	-	-	3/30/0
CHAR	E5	Electrical Characterization	Per Datasheet Parameters	-	1/30/0	1/30/0	-
CHAR	E5	Electrical Distributions	Cpk>1.67 Room, hot, and cold	-	-	-	3/90/0

- QBS: Qual By Similarity
- Qual Device TAS5807MDCPR and TLS2605RDCARG4 are qualified at MSL3 260C
- Preconditioning was performed for Autoclave, Unbiased HAST, THB/Biased HAST, Temperature Cycle, Thermal Shock, and HTSL, as applicable
- The following are equivalent HTOL options based on an activation energy of 0.7eV: 125C/1k Hours, 140C/480 Hours, 150C/300 Hours, and 155C/240 Hours
- $\bullet \quad \text{The following are equivalent HTSL options based on an activation energy of 0.7eV: } 150\text{C/1k Hours, and } 170\text{C/420 Hours}$
- $\bullet \quad \text{The following are equivalent Temp Cycle options per JESD47: -55C/125C/700 Cycles and -65C/150C/500 Cycles}\\$

Quality and Environmental data is available at TI's external Web site: http://www.ti.com/

Green/Pb-free Status:

Qualified Pb-Free(SMT) and Green

TI Qualification ID: R-CHG-2207-055

For questions regarding this notice, e-mails can be sent to the contacts shown below or your local Field Sales Representative.

Location	E-Mail				
WW Change Management Team	PCN www admin team@list.ti.com				

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